



2823
#14/29100
PATENT M.F.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Pai-Hung Pan

Serial No.: 09/072,959

Filed: May 5, 1998

For: TECHNIQUE FOR FORMING
SHALLOW TRENCH ISOLATION
STRUCTURE WITHOUT CORNER
EXPOSURE AND RESULTING
STRUCTURE

Examiner: G. Fourson, III

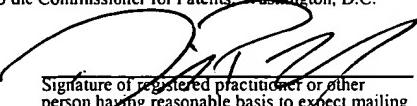
Group Art Unit: 2823

Attorney Docket No.: 2919.1US
(96-499.01)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

December 14, 2000
Date of Deposit


Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

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THIRD SUPPLEMENTAL
INFORMATION DISCLOSURE STATEMENT

Box NON-FEE
Commissioner for Patents
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Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Third Supplemental Information Disclosure Statement be entered and the document listed on attached Form PTO-1449 be considered by the Examiner and made of record. A copy of the listed document is enclosed pursuant to 37 C.F.R. § 1.98(a).

12/22/2000 CVO111 00000014 09072959

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In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Third Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

DOCUMENTS

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Issue Date</u>	<u>Inventor</u>
5,683,932	11/04/1997	Bashir et al.

Applicant offers to supply any explanation or discussion of the document which the Examiner feels is necessary or desirable and which is requested.

This Third Supplemental Information Disclosure Statement is filed after the mailing date of the final Office Action under 37 C.F.R. § 1.113, but before payment of the issue fee. I hereby certify that no item of information contained in the Third Supplemental Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement. Pursuant to 37 C.F.R. § 1.97(d)(ii), applicant hereby petitions for the consideration of the accompanying Third Supplemental Information Disclosure Statement.

The petition fee pursuant to 37 C.F.R. § 1.17(i) for consideration of this Third
Supplemental Information Disclosure Statement is enclosed.

Respectfully submitted,

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Date: December 14, 2000

BGP/jml

Enclosures: Form PTO-1449

Copy of documents cited

Check No. 15441 in the amount of \$180.00 for the petition fee